

L Number	Hits	Search Text	DB	Time stamp
1	1	("6466309").PN.	USPAT	2003/07/09 09:27
2	1	("6362004").PN.	USPAT	2003/07/09 09:31
3	554	(702/150).CCLS.	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:44
5	36	((702/150).CCLS.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:44
6	177	(702/127).CCLS.	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:44
7	9	((702/127).CCLS.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:46
8	10	(356/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:48
9	6	(359/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:49
11	3291	(435/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:51
13	3085	((435/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))) and (spot\$5 or synthesi\$5)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:51
14	285	((435/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))) and (scan\$6 with (wafer\$1 or substrate\$1 or semiconductor\$1 or chip\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 09:52
12	44	(436/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 10:17
15	13	(73/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 10:25
19	8	(345/? .ccls.) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/09 10:26
-	1	("5668894").PN.	USPAT	2003/06/25 10:09
-	1	("5481465").PN.	USPAT	2003/06/25 10:09

	1	("5946645") . PN.	USPAT	2003/06/25 10:09
	7	"5668894"	USPAT	2003/06/25 10:09
	3	"5946645"	USPAT	2003/06/25 10:09
	18	"5481465"	USPAT	2003/06/25 10:28
	365	reagent\$1 near2 cartridge\$1	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 10:29
	24	((reagent\$1 near2 cartridge\$1) with inject\$4)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 10:32
	5	((reagent\$1 near2 cartridge\$1) with inject\$4) and actuat\$7	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 11:51
	50	probe\$1 near2 feature\$1 near2 locat\$6	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 11:53
	587	probe\$1 with feature\$1 with locat\$6	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 10:20
	57	(probe\$1 with feature\$1 with locat\$6) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 10:20
	65	(specif\$6 with (probe\$1 or array\$1 or microarray\$3) with feature\$1 with location\$1)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 15:40
	686	(stor\$6 with location\$1 with data) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with location\$1 with data)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 15:47
	1	(stor\$6 with location\$1 with ((probe\$1 or array\$1) with feature)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with location\$1 with scan\$6)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 15:50
	5	(stor\$6 with location\$1 with ((probe\$1 or array\$1) with feature)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$6)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 15:55
	150	(stor\$6 with location\$1 with (probe\$1 or array\$1 or feature\$1)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$6)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 17:49
	58	(stor\$6 with location\$1 with (probe\$1 or array\$1 or feature\$1)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$6) and (probe\$2 or probing)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 18:08

	86	(stor\$6 with position\$3 with (probe\$1 or array\$1 or feature\$1)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$6) and (probe\$2 or probing)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/26 18:08
	9	(stor\$6 with (location\$1 or position\$3) with (probe\$1 or array\$1) with feature\$1) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/30 09:37
	263	(stor\$6 with (location\$1 or position\$3) with (probe\$1 or array\$1)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/30 09:37
	265	(stor\$6 with (location\$1 or position\$3) with (probe\$1 or array\$3)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/30 09:38
	184	(stor\$6 with (location\$1 or position\$3) with (probe\$1 or array\$3)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5) and ((location\$1 or position\$3) with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/30 09:39
	265	(stor\$6 with (location\$1 or position\$3) with (probe\$1 or array\$3)) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5) and ((location\$1 or position\$3) with (probe\$1 or array\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 09:20
	42	(stor\$6 with (location\$1 or position\$3) with feature\$1) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5) and ((location\$1 or position\$3) with (probe\$1 or array\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 09:21
	123	(stor\$6 with (location\$1 or position\$3) with feature\$1) and ((substrate\$1 or wafer\$1 or semiconductor\$1) with scan\$5) and ((location\$1 or position\$3) with (probe\$1 or array\$3 or feature\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 09:31
	143	(access\$6 with data with scan\$4) and (stor\$5 with (location or position\$3)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 10:14
	132	(access\$6 with data with scan\$4) and (stor\$5 with (location or position\$3)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (probe\$1 or array\$3 or feature\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 10:36
	31	(access\$6 with data with scan\$4) and (stor\$5 with (location or position\$3)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (probe\$1 or array\$3 or feature\$1) with (location\$1 or position\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 10:41
	83	affymetrix and (probe\$1 with feature\$1) and (scan\$6 with (wafer\$1 or semiconductor\$1 or substrate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 10:57
	78	affymetrix and (probe\$1 with feature\$1) and (scan\$6 with (wafer\$1 or semiconductor\$1 or substrate\$1)) and ((location\$1 or position\$3) with (probe\$1 or feature\$1 or array\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 14:33

-	30	affymetrix and (probe\$1 with feature\$1) and (scan\$6 with (wafer\$1 or semiconductor\$1 or substrate\$1)) and ((location\$1 or position\$3) with (probe\$1 or feature\$1 or array\$3)) and (stor\$4 with (location\$1 or position\$3))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 11:24
-	31	affymetrix and (probe\$1 with feature\$1) and (scan\$6 with (wafer\$1 or semiconductor\$1 or substrate\$1)) and ((location\$1 or position\$3) with (probe\$1 or feature\$1 or array\$3)) and ((stor\$4 or memory) with (location\$1 or position\$3))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 11:25
-	50	affymetrix and (probe\$1 with feature\$1) and (scan\$6 with (wafer\$1 or semiconductor\$1 or substrate\$1)) and ((location\$1 or position\$3) with (probe\$1 or feature\$1 or array\$3)) and ((stor\$4 or memory) with (location\$1 or position\$3 or data))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 11:42
-	12	((probe\$1 with feature\$1) with (location\$1 or position\$1 or coordinate\$1)) and (stor\$6 with (position\$3 or location\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1) with (location\$1 or position\$3 or coordinate\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 12:48
-	3	((probe\$1 near2 feature\$1) near2 (location\$1 or position\$1 or coordinate\$1)) and (stor\$6 with (position\$3 or location\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1) with (location\$1 or position\$3 or coordinate\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 12:49
-	27	(probe\$1 with feature\$1 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 14:47
-	20	(probe\$1 with feature\$1 with (location\$1 or position\$3 or coordinate\$1)) and ((memory or database\$1) with (location\$1 or position\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 16:39
-	252	(probe\$1 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$4 with (location\$1 or position\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 15:11
-	162	(probe\$1 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$4 with (location\$1 or position\$3 or coordinate\$1)) and ((scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1)) same (location\$1 or position\$3 or coordinate\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 16:35
-	48	((probe\$1 or array\$4) with feature\$1) with (location\$1 or position\$3 or coordinate\$1)) and ((memory or database\$1) with (location\$1 or position\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/01 16:46

	4	"6349144"	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 08:35
	16	((probe\$1 or array\$4) with feature\$1) with (location\$1 or position\$3 or coordinate\$1)) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and ((memory or database\$1) with (location\$1 or position\$3 or coordinate\$1)) and (scan\$5 with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 09:47
	62	((spot\$4 and synthesiz\$4) with array\$3) with (position\$3 or location\$1 or coordinate\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 08:58
	57	((spot\$4 and synthesiz\$4) with array\$3) with (position\$3 or location\$1 or coordinate\$1)) and scan\$5	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 09:28
	149	((location\$1 or positioning or coordinate\$1) with (array\$3 or probe\$1)) with (substrate\$1 or wafer\$1 or semiconductor\$1)) and (array\$3 with probe\$1) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1)) and (store\$2 or storing)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 09:33
	213	((location\$1 or positioning or coordinate\$1) with (array\$3 or probe\$1)) with (substrate\$1 or wafer\$1 or semiconductor\$1)) and (array\$3 with probe\$1) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:06
	29	specify\$5 with scan\$7 with substrate\$1	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:36
	223	array\$3 near3 manager\$1	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:43
	178	(array\$3 near3 manager\$1) and (location\$1 or position\$3 or coordinate\$1)	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:37
	81	(array\$3 near3 manager\$1) and (location\$1 or position\$3 or coordinate\$1) and scan\$6	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:44
	190	arrayer	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:44
	148	arrayer and (location\$1 or position\$3 or coordinate\$1) and scan\$6	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 10:50
	84	(microarrayer\$1 or (micro adj arrayer\$1)) and (location\$1 or position\$3 or coordinate\$1) and scan\$6	USPAT; US_PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/02 11:27

-	7948	((probe\$1 or array\$4 or feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 09:49
-	1144	((probe\$1 or array\$4 or feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 09:50
-	383	((probe\$1 or array\$4 or feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 09:52
-	233	((probe\$1 or array\$4 or feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and (scan\$6 near3 (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 09:52
-	273	((probe\$1 or array\$4 or feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and ((scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1)) same (location\$1 or position\$3 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 09:54
-	98	((probe\$1 or array\$4 or feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and ((scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1)) same (location\$1 or position\$3 or coordinate\$1)) and probe\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 11:08
-	7	((probe\$1 with feature\$1) near4 (location\$1 or position\$3 or coordinate\$1) with (substrate\$1 or semiconductor\$1 or wafer\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and ((scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1)) same (location\$1 or position\$3 or coordinate\$1)) and probe\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 11:14
-	4	((location\$1 or position\$3 or coordinate\$1) with (spot\$4 or synthesiz\$4) with array\$3 with probe\$1) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 11:19
-	86	((location\$1 or position\$3 or coordinate\$1) with (spot\$4 or synthesiz\$4) with (array\$3 or probe\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 12:11

	49	((location\$1 or position\$3 or coordinate\$1) with (spot\$4 or synthesiz\$4) with (array\$3 or probe\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and ((scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1)) with (location\$1 or position\$3 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 12:12
	65	((location\$1 or position\$3 or coordinate\$1) with (spot\$4 or synthesiz\$4) with (array\$3 or probe\$1)) and (stor\$5 with (location\$1 or position\$3 or coordinate\$1)) and ((scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1)) same (location\$1 or position\$3 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 12:13
	131	(probe\$1 with identifier\$1) and scan\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 12:51
	644	(probe\$1 near3 coordinate\$1) and scan\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 12:51
	59	(probe\$1 near3 coordinate\$1) and (scan\$4 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 13:31
	1074	(specify\$6 with (probe\$1 or array\$3 or feature\$1) with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 13:32
	48	(specify\$6 with (probe\$1 or array\$3 or feature\$1) with (location\$1 or position\$1 or coordinate\$1)) and (scan\$6 with (substrate\$11 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 13:33
	456	((user\$1 with specif\$6) with (location\$1 or position\$3 or coordinate\$1)) with (feature\$1 or probe\$1 or array\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/03 17:07
	8	((user\$1 with specif\$6) with (location\$1 or position\$3 or coordinate\$1)) with (feature\$1 or probe\$1 or array\$3)) and (scan\$5 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/07 09:01
	51	(probe\$1 with feature\$1 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$6 with (location\$1 or data or position\$1 or coordinate\$1)) and (scan\$4 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 09:57
	51	(probe\$1 with feature\$1 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$6 with (location\$1 or data\$5 or position\$1 or coordinate\$1)) and (scan\$4 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/07 11:25
	130	affymetrix and (feature\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/07 18:13

	63	affymetrix and (feature\$1 with (location\$1 or position\$1 or coordinate\$1)) and (scan\$7 with (substrate\$1 or wafer\$1 or semiconductor\$1 or chip\$1)) affymetrix and (arrayer\$1 near2 manager\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 10:41
	5			2003/07/07 19:55
	61	(probe\$1 with feature\$1 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$6 with (location\$1 or data or position\$1 or coordinate\$1)) and (scan\$4 with (substrate\$1 or wafer\$1 or semiconductor\$1 or chip\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/07 19:57
	110	(probe\$1 with array\$3 with (location\$1 or position\$3 or coordinate\$1)) and (stor\$6 with (location\$1 or data or position\$1 or coordinate\$1)) and (scan\$4 with (substrate\$1 or wafer\$1 or semiconductor\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 09:59
	186	affymetrix and (probe\$1 with (location\$1 or position\$1 or coordinate\$1)) and (scan\$7 with (substrate\$1 or wafer\$1 or semiconductor\$1 or chip\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 10:42
	47	(US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.	USPAT; US-PGPUB	2003/07/08 11:36

	3	((US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.) and (well\$1 adj plate\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 11:54
	136	(specify\$6 with probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 11:57
	8	((user\$1 or operator\$1) with specify\$6 with probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 11:59
	79	((user\$1 or operator\$1) with specif\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 15:43
	252	((user\$1 or operator\$1) with select\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 13:46
	93	((user\$1 or operator\$1) with input\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 13:45
	47	((user\$1 or operator\$1) with input\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1)) and scan\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 17:05
	101	((user\$1 or operator\$1) with select\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1)) and scan\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 13:46
	11	((user\$1 or operator\$1) with select\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1)) and (scan\$6 with (substrate\$1 or wafer\$1 or semiconductor\$1 or chip\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 13:47
	15	((user\$1 or operator\$1) with specif\$7 with probe\$1 with (space\$1 or spacing or distance\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/08 14:36

	41	((user\$1 or operator\$1) with select\$7 with probe\$1 with (space\$1 or spacing or distance\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 14:37
	30	((user\$1 or operator\$1) with input\$7 with probe\$1 with (space\$1 or spacing or distance\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 15:42
	4	((user\$1 or operator\$1) with specif\$7 with probe\$1 with (location\$1 or position\$1 or coordinate\$1)) same pattern\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 15:45
	38	((user\$1 or operator\$1) with specif\$7 with pattern\$1) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 15:46
	32	((user\$1 or operator\$1) with input\$7 with pattern\$1) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 15:57
	64	((user\$1 or operator\$1) with select\$7 with pattern\$1) and (probe\$1 with (location\$1 or position\$1 or coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:08
	28	((user\$1 or operator\$1) with select\$7 with (probe\$1 with coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:09
	18	((user\$1 or operator\$1) with input\$7 with (probe\$1 with coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:04
	3	((user\$1 or operator\$1) with specify\$7 with (probe\$1 with coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:15
	947	((location\$1 or position\$3 or coordinate\$1) with probe\$1) and (synthesiz\$3 with array\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:16

	50	(US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$ or US-6190378-\$ or US-6429856-\$ or US-6441973-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.	USPAT; US-PGPUB	2003/07/08 16:17
	27	((US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$ or US-6190378-\$ or US-6429856-\$ or US-6441973-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.) and synthesi\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:37

	36	((US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$ or US-6190378-\$ or US-6429856-\$ or US-6441973-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.) and spot\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:12
	19	((US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$ or US-6190378-\$ or US-6429856-\$ or US-6441973-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.) and (spot\$5 with (array\$1 or probe\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:19
	0	((user\$1 or operator\$1) with (input\$7 or select\$5 or specif\$9) with (nucle\$6 with probe\$1 with coordinate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:49
	8	((user\$1 or operator\$1) with (input\$7 or select\$5 or specif\$9) with (probe\$1 with coordinate\$1)) and nucle\$8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 16:49
	197	arrayer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:04

-	9	(scanning with area with specifying).ti.	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:06
-	166	arrayer and probe\$1	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:08
-	158	arrayer and probe\$1 and (location\$1 or position\$3 or coordinate\$1)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:09
-	70	arrayer and (probe\$1 with (location\$1 or position\$3 or coordinate\$1))	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:09
-	2	((US-6567163-\$ or US-6489611-\$ or US-6459807-\$ or US-6428957-\$ or US-6391550-\$ or US-6329140-\$ or US-6284465-\$ or US-6267005-\$ or US-6172757-\$ or US-5948972-\$ or US-5317141-\$ or US-6520005-\$ or US-6406849-\$ or US-6272392-\$ or US-6407858-\$ or US-6392229-\$ or US-6288782-\$ or US-6262838-\$ or US-5923430-\$ or US-6518056-\$ or US-6516276-\$ or US-5856101-\$ or US-6587579-\$ or US-6420180-\$ or US-6180351-\$ or US-5506793-\$).did. or (US-6215894-\$ or US-6558623-\$ or US-6542830-\$ or US-4571638-\$ or US-6455847-\$ or US-5427910-\$ or US-6531279-\$ or US-6480791-\$ or US-5925525-\$ or US-5874219-\$ or US-5593839-\$ or US-5519686-\$ or US-5837832-\$ or US-5795716-\$ or US-5631734-\$ or US-6190378-\$ or US-6429856-\$ or US-6441973-\$).did. or (US-20010053519-\$ or US-20020174714-\$ or US-20020064774-\$ or US-20030028501-\$ or US-20020098479-\$ or US-20020098534-\$).did.) and arraying	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/08 17:12